

ABSTRACT OF THE DISCLOSURE

SURFACE MOUNT TYPE ELECTRONIC COMPONENTS

5 Provided is a surface mount type electronic
component which is obtained by molding a liquid crystalline
polymer composition comprising: 100 parts by weight of a
10 wholly aromatic liquid crystalline polymer having a
crystalline melting temperature of 310-410°C, and 5-100
parts by weight of a glass fiber having a number average
diameter of 4-8 μ m and a number average length of 100-200 μ m,
wherein the LCP composition has a deflection temperature
under load (DTUL) of 280-360°C.

No Figure



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